





SJ-5303 (CLEAR)



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DNP

FID1

DNP

FID2

DNP

FID3



CAUTION HOT SURFACE

PCB Number: MDBU006

PCB Rev: A

PCB

LOGO

Texas Instruments

PCB

LOGO

Pb-Free Symbol

PCB

LOGO

FCC disclaimer

Label Table

Variant	Label Text
001	DRV8870EVM
002	DRV8872EVM

LBL1

PCB Label

Size: 0.65" x 0.20 "

ZZ1

Label Assembly Note

This Assembly Note is for PCB labels only

ZZ2

Assembly Note

These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3

Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4

Assembly Note

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

ZZ5

Assembly Note

Shorting plug TP10 shall be raised to minimum height of 250mils above PCB

Orderable: <a href="#">DRV8872EVM</a>		Designed for: <a href="#">Public Release</a>		Mod. Date: 7/17/2015	
TID #: <a href="#">N/A</a>		Project Title: <a href="#">DRV8870/2EVM</a>			
Number: <a href="#">MDBU006</a>		Rev: <a href="#">A</a>		Sheet Title:	
SVN Rev: Version control disabled		Assembly Variant: <a href="#">002</a>			Sheet: <a href="#">3</a> of <a href="#">3</a>
Drawn By:		File: <a href="#">MDBU006A_Hardware.SchDoc</a>			Size: B
Engineer: <a href="#">Rick Duncan</a>		Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>			

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